Page 1 of 1 Subst. Form PTO-1449 Atty. Docket No.: D/A0597 Serial No.: 09/725,836 XER 2 0368 APPLICANT'S(S') INFORMATION Applicant(s): Michel A. Rosa, et al. **DISCLOSURE STATEMENT** Filing Date: November 29, 2000 Group: 2841 **U.S. PATENT DOCUMENTS** Class Subcl. Filing Date Initial* Document No. Date Name AA AB AC AD ΑE AF AG AΗ ΑI ΑJ ΑK FOREIGN PATENT DOCUMENTS Document No. Date Class Subcl. Translation? Country ΑL AM AN AO ΑP OTHER ART Deborah S. Patterson, Flip Chip Technologies, 3701 E. University Drive, Phoenix, AZ, Seminar, A Comparison of Popular Flip Chip Bumping Technologies (Test, Assembly & Packaging Conference AR (InterPACK '97), in Kona, HW, 1997). AS AΤ Examiner: Date Considered: EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if in conformance and not considered. Include copy of this form with next communication to applicant.